ETR28004-003

Inductor Built-in Step-up "micro DC/DC" Converter

☆GreenOperation Compatible

■GENERAL DESCRIPTION

The XCL101 series is a synchronous step-up micro DC/DC converter which integrates an inductor and a control IC in one tiny package ($2.5mm \times 2.0mm$, H=1.0mm). A stable step-up power supply is configured using only two capacitors connected externally. An internal coil simplifies the circuit and enables minimization of noise and other operational trouble due to the circuit wiring. The XCL101 series can be used in applications that start from a single alkaline or nickel-metal hydride battery because the input voltage range is $0.9V \sim 5.5V$. The output voltage can be set from 1.8V to 5.0V ($\pm 2.0\%$) in steps of 0.1V. PFM control enables a low quiescent current, making these products ideal for portable devices that require high efficiency. The XCL101 features a load disconnect function to break continuity between the input and output at shutdown (XCL101A), and a bypass mode function to maintain continuity between the input and output (XCL101C).

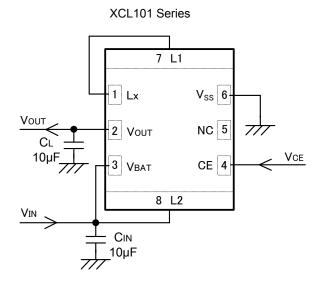
■APPLICATIONS

- Wearable devices
- Mobile phones, Smart phones
- Mouses, Keyboards
- Remote controls
- Portable information devices
- Game consoles

FEATURES

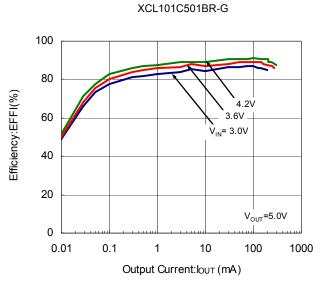
Input Voltage Range	:	0.9V~5.5V
Output Voltage Range	:	1.8V~5.0V (±2.0%) 0.1V increment
Output Current	:	100mA@Vout=3.3V, VBAT=1.8V (TYP.)
Supply Current	:	6.3µA (Vbat=Vout+0.5V)
Control Method	:	PFM Control
PFM Switching Current	:	350mA
Functions	:	Load Disconnection Function or
		Bypass Mode Function
		Ceramic Capacitor Compatible
Operating Ambient Temperature	:	-40°C ~ +85°C
Package	:	CL-2025, CL-2025-02
Environmentally Friendly	:	EU RoHS Compliant, Pb Free

■ TYPICAL APPLICATION CIRCUIT



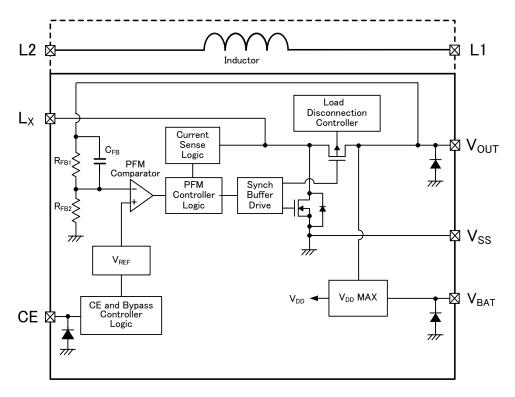
(TOP VIEW) "L1 and Lx", "L2 and VBAT" is connected by PCB pattern.

■ TYPICAL PERFORMANCE CHARACTERISTICS



■BLOCK DIAGRAM

XCL101A / XCL101C



* Diodes inside the circuits are ESD protection diodes and parasitic diodes.

■ PRODUCTION CLASSIFICATION

Ordering Information

XCL101123456-7)(*1) PFM control

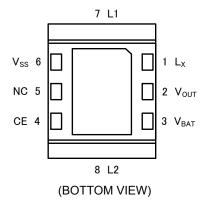
DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
A	Dreduct Turc	А	Load Disconnection
1	Product Type	С	V _{BAT} Bypass
23	Output Voltage	18~50	Output Voltage e.g. Vou⊤=1.8V ⇒ ②=1、③=8
4	Oscillation Frequency	1	1.2MHz
56-7	Package	BR-G ^(*2)	CL-2025 (3,000/Reel)
	(Order Unit)	ER-G ^(*3)	CL-2025-02 (3,000/Reel)

(*1)The "-G" suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant.

(*2) BR-G is storage temperature range "-40 $\,^\circ \! C \,$ ~ + 105 $\,^\circ \! C$ ".

(*3) ER-G is storage temperature range "-40 $\,^{\circ}\!C\,$ ~ + 125 $\,^{\circ}\!C$ ".

■ PIN CONFIGURATION



- * If the dissipation pad needs to be connected to other pins, it should be connected to the $V_{\mbox{\scriptsize SS}}$ pin.
- * Please refer to pattern layout page for the connecting to PCB.

■ PIN ASSIGNMENT

PIN NUMBER	PIN NAME FUNCTIONS		
1	L _X	Switching	
2	Vout	Output Voltage	
3	VBAT	Power Input	
4	CE	Chip Enable	
5	NC	No Connection	
6	Vss	Ground	
7	L1	- Inductor Electrodes	
8	L2		

■CE PIN FUNCTION

PIN NAME	SIGNAL	STATUS
	Н	Operation (All Series)
CE	L	XCL101A Series : Stand-by XCL101C Series : Bypass Mode

* Please do not leave the CE pin open.

ABSOLUTE MAXIMUM RATINGS

Ta=25⁰C

PARAMET	ER	SYMBOL RATINGS		UNITS
V _{BAT} Pin Vol	tage	V _{BAT}	-0.3 ~ +7.0	V
L _X Pin Volta	age	V _{LX}	V_{LX} -0.3 ~ V_{OUT} +0.3 or +7.0 (*1)	
Vout Pin Vol	Vout Pin Voltage		-0.3 ~ +7.0	V
CE Pin Voltage		V _{CE}	-0.3 ~ +7.0	V
Lx Pin Current		I _{LX}	700	mA
Power Dissipation		Pd	1000 (*2)	mW
Operating Ambient Temperature		Topr - 40 ~ +85		°C
Storage	StorageCL-2025Temperature(*3)CL-2025-02		- 40 ~ +105	°C
Temperature ^(*3)			(*3)	Tstg

All voltages are described based on the GND.

(*1) The maximum value should be either VOUT+0.3V or +7.0V in the lowest.

(*2) The power dissipation figure shown is PCB mounted (40mm x 40mm, t=1.6mm, Glass Epoxy FR-4).

(*3) Storage temperature, are divided by the product specification of the package.

■ELECTRICAL CHARACTERISTICS

XCL101Axx1BR-G/XCL101Axx1ER-G

							Ta=25 °C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Input Voltage	VBAT	-	-	-	5.5	V	-
Output Voltage	V _{OUT(E)} ^(*2)	V_{PULL} =1.5V, Voltage to strat oscillation while V_{OUT} is decreasing		<e1></e1>		V	1
Operation Start Voltage	V _{ST1}	Iout=1mA	-	-	0.9	V	2
Operation Hold Voltage	VHLD	RL=1kΩ	-	0.7	-	V	2
Supply Current	lq	Oscillation stops, $V_{BAT}=V_{CE}=1.5V$ $V_{OUT}=V_{OUT(T)}$ ^(*1) +0.5V		<e2></e2>		μA	3
Input Pin Current	IBAT	Vout=Vout(t) (*1)+0.5V	-	0.25	1.0	μA	3
Stand-by Current	ISTB	VBAT=VLX=VOUT(T) ^(*1) , VOUT=VCE=0V	-	0.1	1.0	μA	4
Lx Leak Current	Ilxl	$V_{BAT}=V_{LX}=V_{OUT(T)}$, $V_{OUT}=V_{CE}=0V$	-	0.1	1.0	μA	5
PFM Switching Current	IPFM	lout=3mA	295	350	405	mA	2
Maxixmum On Time	tonmax	VPULL=1.5V, VOUT=VOUT(T) (*1)×0.98V	3.1	4.6	6.0	μs	1
L _X SW "Pch" ON Resistance ^(*3)	R _{LXP}	$V_{BAT}=V_{CE}=V_{LX}=V_{OUT(E)}$ (*2)+ 0.5V, I _{OUT} =200mA		<e3></e3>		Ω	Ø
L _X SW "Nch" ON Resistance ^(*4)	R _{LXN}	V _{BAT} =V _{OUT(E)} ^(*2) =3.3V, V _{OUT} =1.7V	-	0.6	-	Ω	8
CE "High" Voltage	Vсен	$\label{eq:VBAT} \begin{array}{l} V_{BAT} = V_{PULL} = 1.5V \\ V_{OUT} = V_{OUT(T)} {}^{(1)} \times 0.98V \\ While \ V_{CE} = 0.3 {\rightarrow} 0.75V, \\ Voltage \ to \ start \ oscillation \end{array}$	0.75	-	5.5	V	1
CE "Low" Voltage	Vcel	$\label{eq:VBAT} \begin{array}{l} V_{BAT} = V_{PULL} = 1.5V \\ V_{OUT} = V_{OUT(T)} \stackrel{(^{+1})}{\longrightarrow} 0.98V \\ \mbox{While } V_{CE} = 0.75 \rightarrow 0.3V, \\ \mbox{Voltage to stop oscillation} \end{array}$	Vss	-	0.3	V	1
CE "High" Current	I _{CEH}	V _{BAT} =V _{CE} =V _{LX} =V _{OUT} =5.5V	-0.1	-	0.1	μA	1
CE "Low" Current	ICEL	VBAT=VLX=VOUT=5.5V, VCE=0V	-0.1	-	0.1	μA	1
Inductance Value	L	Test Frequency=1MHz	-	4.7	-	μH	-
(Inductor) Rated Current	I _{DC}	ΔT=+40°C	-	700	-	mA	-

0 - 00

Unless otherwise stated, V_{BAT} = V_{CE} = 1.5V

(*1) VOUT(T) =Nominal Output Voltage

(*2) VOUT(E) = Effective Output Voltage

The actual output voltage value $V_{OUT(E)}$ is the PFM comparator threshold voltage in the IC. Therefore, the DC/DC circuit output voltage, including the peripheral components, is boosted by the ripple voltage average value. Please refer to the characteristic example.

 $^{(^{*3})}$ Lx SW "Pch" ON resistance =(V_Lx-V_{OUT}pin measurement voltage) / 200mA

(*4) L_X SW "Nch" ONresistance measurement method is shown in the measurement circuit diagram.

■ ELECTRICAL CHARACTERISTICS (Continued)

XCL101Cxx1BR-G/XCL101Cxx1ER-G

							Ta=25 ℃
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Input Voltage	VBAT	-	-	-	5.5	V	-
Output Voltage	V _{OUT(E)} ^(*2)	V_{PULL} =1.5V, Voltage to strat oscillation while V_{OUT} is decreasing		<e1></e1>		V	1
Operation Start Voltage	V _{ST1}	Iout=1mA	-	-	0.9	V	2
Operation Hold Voltage	Vhld	R∟=1kΩ	-	0.7	-	V	2
Supply Current	lq	Oscillation stops, V _{OUT} =V _{OUT(T)} +0.5V ^(*1)		<e2></e2>		μA	3
Input Pin Current	IBAT	$V_{BAT}=V_{CE}=1.5V$, $V_{OUT}=V_{OUT(E)}$ (*2)+0.5V	-	0.25	1.0	μA	3
Bypass Mode Current	IBYP	V _{BAT} =V _{LX} =5.5V, V _{CE} =0V	-	3.5	6.1	μA	6
PFM Switching Current	IPFM	lout=3mA	295	350	405	mA	2
Maxixmum On Time	tonmax	VPULL=1.5V, VOUT=VOUT(T) ^(*1) ×0.98V	3.1	4.6	6.0	μs	1
L _X SW "Pch" ON Resistance ^(*3)	RLXP	$V_{BAT}=V_{LX}=V_{CE}=V_{OUT(E)}^{(*2)}+0.5V,$ Iout=200mA		<e3></e3>		Ω	Ø
L _X SW "Nch" ON Resistance ^(*4)	RLXN	V _{BAT} =V _{OUT(E)} ^(*2) =3.3V, V _{OUT} =1.7V	-	0.6	-	Ω	8
CE "High" Voltage	Vсен	$\label{eq:VBAT} \begin{split} & V_{BAT} = V_{PULL} = 1.5V \\ & V_{OUT} = V_{OUT(T)}^{(*1)} \times 0.98V \\ & \text{While } V_{CE} = 0.3 {\rightarrow} 0.75V, \\ & \text{Voltage to start oscillation} \end{split}$	0.75	-	5.5	V	1
CE "Low" Voltage	V _{CEL}	$\label{eq:VBAT} \begin{array}{l} V_{BAT} = V_{PULL} = 1.5 V \\ V_{OUT} = V_{OUT(T)} ^{(11)} \times 0.98 V \\ \mbox{While } V_{CE} = 0.75 \rightarrow 0.3 V, \\ \mbox{Voltage to stop oscillation} \end{array}$	V _{SS}	-	0.3	V	1
CE "High" Current	ICEH	VBAT=VCE=VLX=VOUT=5.5V	-0.1	-	0.1	μA	1
CE "Low" Current	ICEL	VBAT=VLX=VOUT=5.5V, VCE=0V	-0.1	-	0.1	μA	1
Inductance Value	L	Test Frequency=1MHz	-	4.7	-	μH	-
(Inductor) Rated Current	IDC	ΔT=+40°C	-	700	-	mA	-

Unless otherwise stated, $V_{\text{BAT}}\text{=}V_{\text{CE}}\text{=}1.5V$

(*1) V_{OUT(T)} =Nominal Output Voltage

(*2) V_{OUT(E)} =Effective Output Voltage

The actual output voltage value V_{OUT(E)} is the PFM comparator threshold voltage in the IC. Therefore, the DC/DC circuit output voltage, including the peripheral components, is boosted by the ripple voltage average value. Please refer to the characteristic example.

 $^{(^{*3})}$ Lx SW "Pch" ON resistance =(V_Lx-V_{OUT}pin measurement voltage) / 200mA

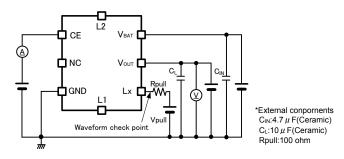
(*4) Lx SW "Nch" ONresistance measurement method is shown in the measurement circuit diagram.

■ELECTRICAL CHARACTERISTICS (Continued)

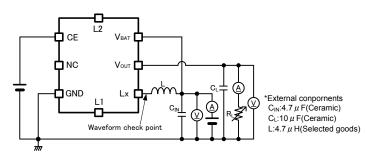
SYMBOL	E	1	E	2	E	3
PARAMETER	OUTPUT VOLTAGE		SUPPLY	CURRENT	L _X SW "Pch" ON RESISTANCE	
UNITS:V	UNI	TS:V	UNIT	ΓS:μA	UNITS:Ω	
OUTPUT VOLTAGE	MIN	MAX	TYP	MAX	TYP	MAX
1.8	1.764	1.836				
1.9	1.862	1.938				
2.0	1.960	2.040	6.1	9.4	0.84	1.08
2.1	2.058	2.142				
2.2	2.156	2.244				
2.2	2.150	2.244				
2.4	2.352	2.448	-			
2.5	2.450	2.550	-			
2.6	2.548	2.652	6.2	9.7	0.75	0.97
2.7	2.646	2.754		•	011.0	0101
2.8	2.744	2.856	-			
2.9	2.842	2.958	-			
3.0	2.940	3.060				
3.1	3.038	3.162	-			
3.2	3.136	3.264	6.3	10.0	0.65	0.85
3.3	3.234	3.366				
3.4	3.332	3.468				
3.5	3.430	3.570				
3.6	3.528	3.672				
3.7	3.626	3.774	6.4	10.2	0.61	0.78
3.8	3.724	3.876				
3.9	3.822	3.978				
4.0	3.920	4.080				
4.1	4.018	4.182				
4.2	4.116	4.284	6.5	10.4	0.57	0.74
4.3	4.214	4.386				
4.4	4.312	4.488				
4.5	4.410	4.590				
4.6	4.508	4.692				
4.7	4.606	4.794	6.7	10.7	0.53	0.72
4.8	4.704	4.896	0.7	10.7	0.00	0.72
4.9	4.802	4.998				
5.0	4.900	5.100				

■TEST CIRCUITS

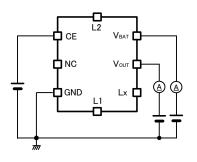
<Test Circuit No.①>



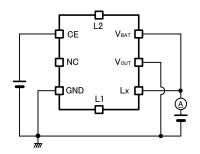
<Test Circuit No.(2)>



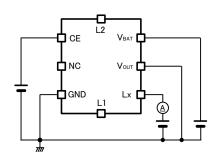
<Test Circuit No.(3)>



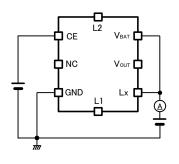
<Test Circuit No.(4)>



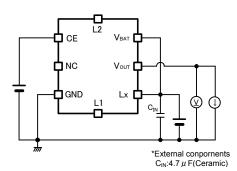
<Test Circuit No.(5)>



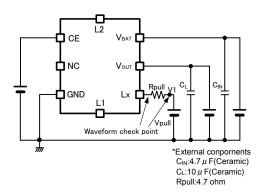
<Test Circuit No.6>



<Test Circuit No.⑦>



<Test Circuit No.(8)>



<LX SW "Nch" ON Resistance Measurement Method>

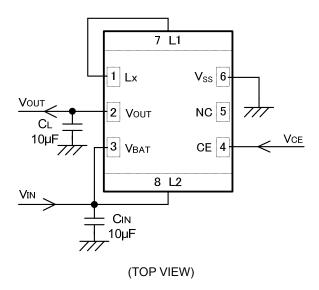
Use Test Circuit No.8 to adjust V_{pull} so that the Lx pin voltage becomes 100mV when the Nch drive Tr is ON and then the voltage at both ends of R_{pull} is measured to find the Lx SW "Nch" ON resistance.

RLXN=0.1 / {(V1 - 0.1) / 4.7)}

Note that V1 is the R_{pull} previous voltage when the Nch driver Tr is ON. Use an oscilloscope or other instrument to measure the Lx pin voltage and V1.



■TYPICAL APPLICATION CIRCUIT



* The embedded coil is optimized for XCL101 series. Please do not use for other purposes.

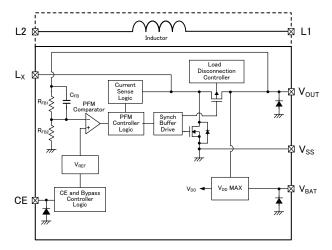
	MANUFACTURE	PRODUCT NUMBER VALUE		L×W (mm)
		C1608JB1A106K	10µF/10V	1.60 × 0.80
	ТDК	C1608X5R1A106K	10µF/10V	1.60 × 0.80
		C2012JB1A106K	10µF/10V	2.00 × 1.25
		C2012X5R106K	10µF/10V	2.00 × 1.25
CIN, CL		LMK107BBJ106MALT	10µF/10V	1.60 × 0.80
		LMK212ABJ106KG	10µF/10V	2.00 × 1.25
	TAIYO YUDEN	LMK212BBJ226MG	22µF/10V	2.00 × 1.25
	JMK212BBJ476MG	47µF/6.3V	2.00 × 1.25	

[Recommended External Components	5]
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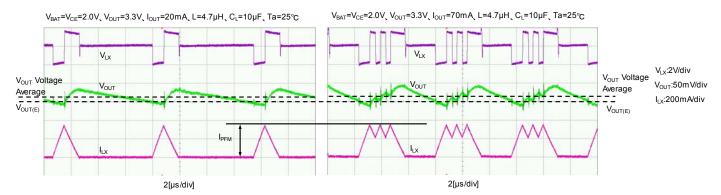
■OPERATION EXPLANATION

The XCL101 Series consists of a standard voltage source, a PFM comparator, a Nch driver Tr, a Pch synchronous rectifier switch Tr, a current sense circuit, a PFM control circuit and a CE control circuit, etc. (refer to the block diagram below.)



Current limit PFM control is used for the control method to make it difficult for the output voltage ripple to increase even when the switching current is superimposed, so the product can be used within a wide voltage and current range. Further, because PFM control is used, it has excellent transient response to support low capacity ceramic capacitors to realize a compact, high-performance boost DC/DC converter. The synchronous driver and rectifier switch Tr efficiently sends the coil energy to the capacitor connected to the Vour pin to achieve highly efficient operation from low to high loads.

The electrical characteristics actual output voltage V_{OUT(E)} is the PFM comparator threshold voltage shown in the block diagram. Therefore, the booster circuit output voltage average value, including the peripheral components, depends on the ripple voltage, so this must be carefully evaluated before being used in the actual product.



< Reference Voltage Source (VREF)>

The reference voltage source (VREF voltage) provides the reference voltage to ensure stable output voltage of the DC/DC converter.

< PFM Control >

①The voltage from the output voltage divided by the division resistors R_{FB1} and R_{FB2} in the IC is used as feedback voltage (FB voltage), and the PFM comparator is compared with the FB voltage and V_{REF}. If the FB voltage is lower than V_{REF}, the signal is sent to the buffer driver via the PFM control circuit and the Nch driver Tr is turned ON. If the FB voltage is higher than V_{REF}, the PFM comparator sends a signal that does not turn ON the Nch driver Tr.

⁽²⁾The current sense circuit monitors the current flowing in the Nch driver Tr connected to the Lx pin when the Nch driver Tr is ON. When the prescribed PFM switching current (I_{PFM}) is reached, the signal is sent to the buffer driver via the PFM control circuit to turn OFF the Nch driver Tr and turn ON the Pch synchronous rectifier switch Tr.

^③The Pch synchronous rectifier switch Tr ON time (off time) is dynamically optimized internally. After the off time has passed, when the PFM comparator confirms the Vout voltage has exceeded the set voltage, a signal that does not allow the Nch driver Tr to be turned on is sent from the PFM comparator to the PFM control circuit, but if the Vout voltage remains lower than the set voltage, then Nch driver Tr ON is started.

The intervals of the above ①②③ linked operations are continuously adjusted in response to the load current to ensure the output voltage is kept

stable from low to high loads and that it is done with good efficiency.

OPERATION EXPLANATION (Continued)

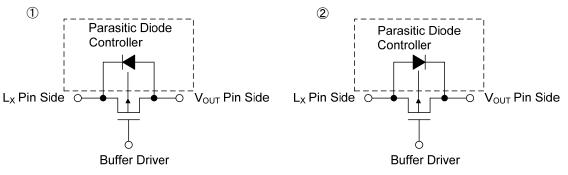
<PFM Switching Current>

The PFM switching current unit monitors the current flowing in the Nch driver Tr and functions to limit the current flowing in the Nch driver Tr, but if the load current becomes much larger than the PFM switching energy, the Vour voltage becomes lower and prevents the coil current in the Nch driver Tr OFF period from lowering, which affects the internal circuit delay time and results in an excessive current that is larger than the PFM switching current flowing in the Nch driver Tr and Pch synchronous rectifier switch Tr.

<Load Disconnection Function, Bypass Mode>

When "L" voltage is input to the CE pin, the XCL101A type enters into standby mode and the XCL101C type enters into bypass mode to stop the circuit required for the boost operation. In the standby mode the load cut-off function operates and both the Nch driver Tr and Pch synchronous rectifier switch Tr are turned OFF, which cuts off the current to the L_x pin and V_{OUT} pin and the parasitic diode control circuit connects the parasitic diode cathode of the Pch synchronous rectifier switch Tr to the L_x pin (1). In the bypass mode the Nch driver Tr is OFF, the Pch synchronous rectifier switch Tr is ON when $V_{LX} > V_{OUT}$, and the parasitic diode control circuit connects the parasitic diode cathode of the Pch synchronous rectifier switch Tr to the V_{OUT} pin (2). Also, when $V_{LX} < V_{OUT}$, the Pch synchronous rectifier switch Tr is turned OFF and the parasitic diode cathode is connected to the V_{OUT} pin (2).

Note: Except for the moment when the V_{BAT} voltage rises up under a start-up condition.

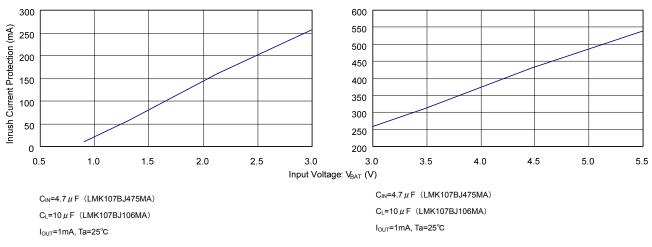


< VBAT-VOUT Voltage Detection Circuit>

The V_{BAT}-V_{OUT} voltage detection circuit compares the V_{BAT} pin voltage with the V_{OUT} pin voltage, and whichever is the highest is operated to become the IC power supply (V_{DD}). In addition, if, during normal operation, the input voltage becomes higher than the output voltage, the Nch driver Tr is turned OFF and the Pch synchronous rectifier switch Tr is kept ON so that the input voltage pass through to the output voltage (through mode). When the input voltage becomes lower than the output voltage, the circuit automatically returns to the normal boost operation. This detection circuit does not operate when in the standby mode.

<Inrush Current Protection Function>

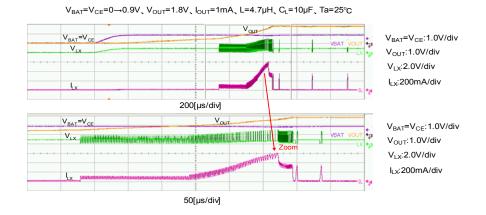
When the V_{BAT} or V_{CE} power supply is input, C_L is charged via the stable current that results from the inrush current protection function (refer to graphs below). Therefore, this function minimizes potential over current from the V_{BAT} pin to the V_{OUT} pin. Also, this current value depends on the V_{BAT} voltage. After CL is charged by the aforementioned stable current and V_{OUT} reaches around the V_{BAT} voltage level, the inrush current protection function will be released after several hundred μ s ~ several ms and the IC will then move to step-up mode, by pass mode or through mode.



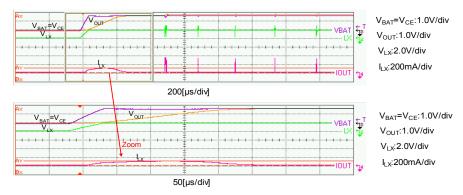
Inrush Current Protection Characteristics

■NOTE ON USE

- 1. Be careful not to exceed the absolute maximum ratings for externally connected components and this IC.
- 2. The DC/DC converter characteristics greatly depend not only on the characteristics of this IC but also on those of externally connected components, so refer to the specifications of each component and be careful when selecting the components. Be especially careful of the characteristics of the capacitor used for the load capacity C_L and use a capacitor with B characteristics (JIS Standard) or an X7R/X5R (EIA Standard) ceramic capacitor.
- 3. Use a ground wire of sufficient strength. Ground potential fluctuation caused by the ground current during switching could cause the IC operation to become unstable, so reinforce the area around the GND pin of the IC in particular.
- 4. Mount the externally connected components in the vicinity of the IC. Also use short, thick wires to reduce the wire impedance.
- 5. An excessive current that is larger than the PFM switching current flowing in the Nch driver Tr and Pch synchronous rectifier switch Tr, which could destroy the IC.
- 6. When in the bypass mode, the internal Pch synchronous rectifier switch Tr turns ON to allow current to flow to the Lx pin and Vour pin. When an excessive current comes from the Vour pin when this bypass operates, it could destroy the Pch synchronous rectifier switch Tr.
- 7. The CE pin does not have an internal pull-up or pull-down, etc. Apply the prescribed voltage to the CE pin.
- 8. The embedded coil is optimized for XCL101 series. Please do not use for other purposes.
- 9. At high temperatures, the product performance could vary causing the efficiency to decline. Evaluate this carefully before use if the product will be used at high temperatures.
- 10. Please note that the leak current of the Pch synchronous rectifier switch Tr during high-temperature standby operation could cause the output voltage to increase.
- 11. When the voltage difference between V_{IN} and V_{OUT} is small, switching energy increases and there is a possibility that the ripple voltage will betoo large. And when the ripple voltage becomes big by influence of a load current, please add the C_L capacitor.
- 12. When the booster circuit is activated by a low input voltage, during the time until the output voltage reaches about 1.7V, the PFM switching current function might not operate causing the coil current to be superimposed. (See the figure below.)

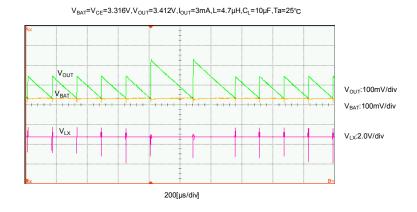


V_{BAT}=V_{CE}=0→1.7V、V_{OUT}=1.8V、I_{OUT}=1mA、L=4.7µH、C_L=10µF、Ta=25℃



■NOTE ON USE (Continued)

- 13. If the C_L capacity or load current becomes excessively large, the output voltage start-up time, when the power is turned on, will increase, so the coil current might be superimposed during the time it takes for the output voltage to become sufficiently higher than the V_{BAT} voltage.
- 14. If the input voltage is higher than the output voltage, then the circuit automatically enters the through mode. When the input voltage becomes close to the output voltage, there could be repeated switching between the boost mode and through mode causing the ripple voltage to fluctuate. (Refer to the graphic below)



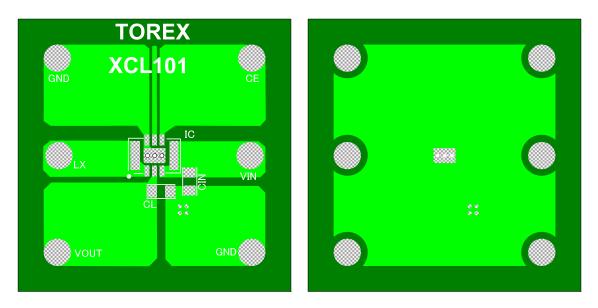
- 15. If a different power supply is connected from an external source to the XCL101A/XCL101C, the IC could be destroyed.
- 16. For temporary, transitional voltage drop or voltage rising phenomenon, the IC is liable to malfunction should the ratings be exceeded.
- 17. Torex places an importance on improving our products and their reliability. We request that users incorporate fail-safe designs and post-aging protection treatment when using Torex products in their systems.
- 18. With the XCL101A, when the VBAT or VCE power supply is input, if the VOUT pin voltage does not exceed VBAT -0.35V, which can happen due to the load current being more than the inrush protection current, step-up mode or through mode operations won't function correctly.
- 19. With the XCL101C, when the VBAT power supply is input, if the Vour pin voltage does not exceed VBAT -0.35V, which can happen due to the load current being more than the inrush protection current, by pass mode operations won't function correctly.

■NOTE ON USE (Continued)

Instruction of pattern layouts

- 1. In order to stabilize VBAT voltage level, we recommend that a by-pass capacitor (CIN) be connected as close as possible to the VBAT and ground pins.
- 2. Please mount each external component as close to the IC as possible.
- 3. Wire external components as close to the IC as possible and use thick, short connecting traces to reduce the circuit impedance.
- 4. Make sure that the ground traces are as thick as possible, as variations in ground potential caused by high ground currents at the time of switching may result in instability of the IC.
- 5. Internal driver transistors bring on heat because of the transistor current and ON resistance of the driver transistors.

Recommended Pattern Layout

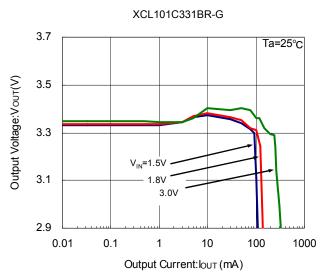


<Top view>

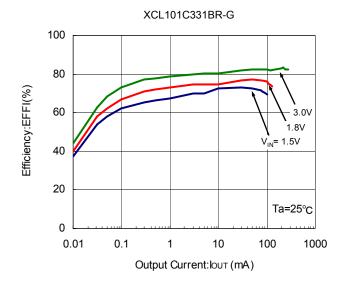
<Bottom view>

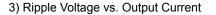
■TYPICAL PERFORMANCE CHARACTERISTICS

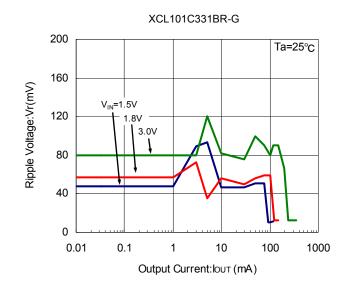
1) Output Voltage vs. Output Current

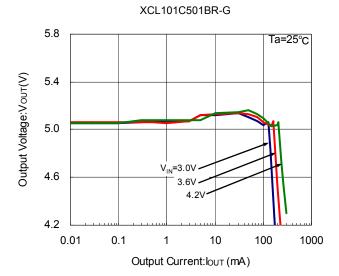


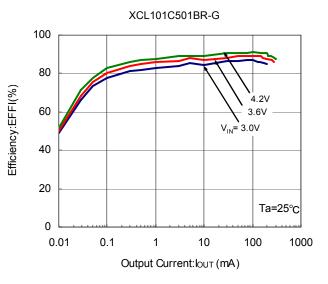
2) Efficiency vs. Output Current

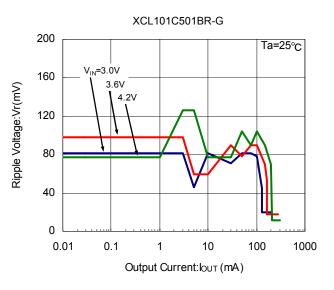








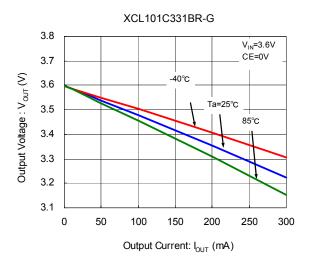


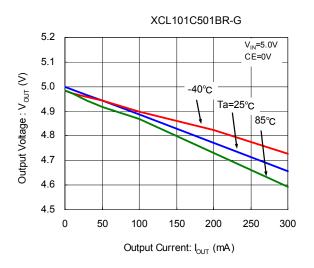


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■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

4) Bypass Voltage vs. Output Current



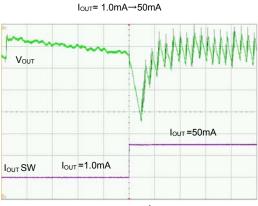


5) Load Transient Response



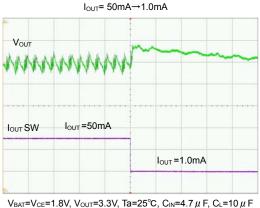
 $V_{\text{BAT}}=V_{\text{CE}}=1.8\text{V}, V_{\text{OUT}}=3.3\text{V}, \text{ Ta}=25^{\circ}\text{C}, \text{ C}_{\text{IN}}=4.7\,\mu\text{ F}, \text{ C}_{\text{L}}=10\,\mu\text{ F}$ $V_{\text{OUT}}:50\text{mV/Div}, \text{ I}_{\text{OUT}}:\text{SW}:1.0\text{V/Div}, \text{ Time}:20\,\mu\text{ s}$

XCL101C501BR-G



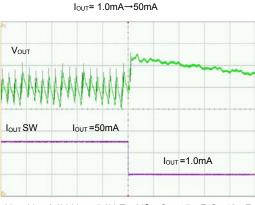
 $V_{BAT}=V_{CE}=3.0V, V_{OUT}=5.0V, Ta=25^{\circ}C, C_{IN}=4.7 \ \mu \text{ F}, C_{L}=10 \ \mu \text{ F}$ $V_{OUT}:50mV/Div, I_{OUT} SW:1.0V/Div, Time:20 \ \mu \text{ s}$

XCL101C331BR-G



 $V_{BAT} = V_{CE} = 1.8V$, $V_{OUT} = 3.3V$, Ia = 25 C, $C_{IN} = 4.7 \mu$ F, $C_L = 10$ $V_{OUT} : 50 \text{mV/Div}$, I_{OUT} SW:1.0V/Div, Time:20 μ s

XCL101C501BR-G

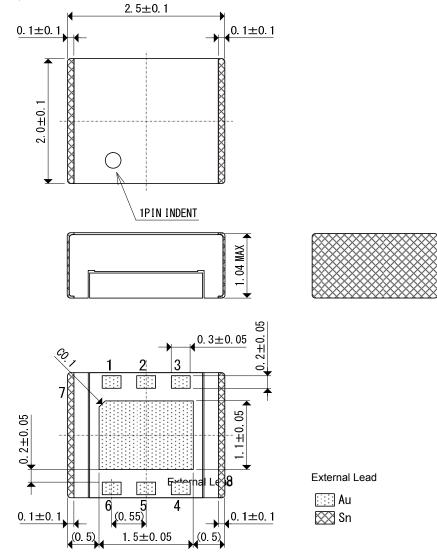


$$\label{eq:VBAT} \begin{split} V_{\text{BAT}} = V_{\text{CE}} = 3.0 \text{V}, \ V_{\text{OUT}} = 5.0 \text{V}, \ \text{Ta} = 25^{\circ} \text{C}, \ \text{C}_{\text{IN}} = 4.7 \ \mu \text{ F}, \ \text{C}_{\text{L}} = 10 \ \mu \text{ F} \\ V_{\text{OUT}} : 50 \text{mV} / \text{Div}, \ \text{I}_{\text{OUT}} : \text{SW} : 1.0 \text{V} / \text{Div}, \ \text{Time} : 20 \ \mu \text{ s} \end{split}$$

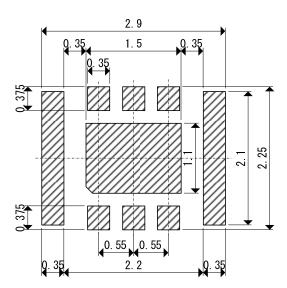
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■PACKAGING INFORMATION

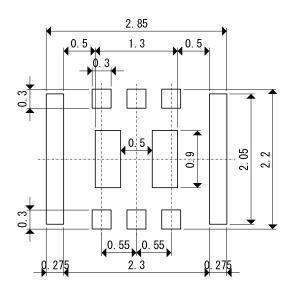
•CL-2025 (unit: mm)



•Reference Pattern Layout (unit:mm)

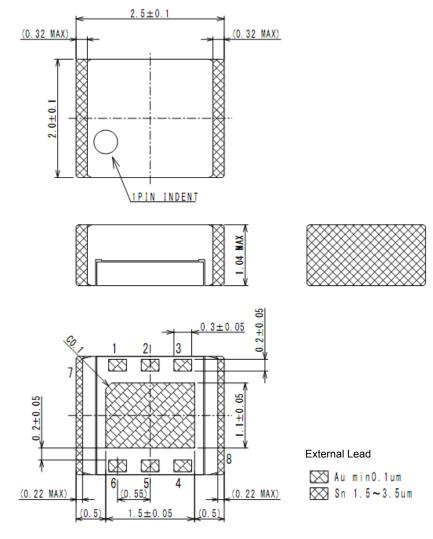


Reference Metal Mask Design (unit:mm)



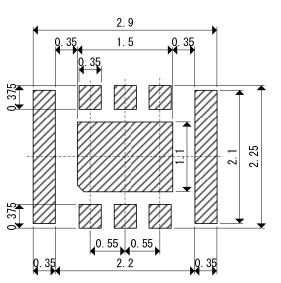
■ PACKAGING INFORMATION

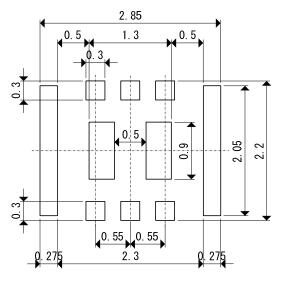
•CL-2025-02 (unit: mm)



Reference Pattern Layout (unit:mm)

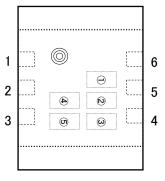
Reference Metal Mask Design (unit:mm)





*Implementation of CL-2025-02 is recommended within accuracy 0.05mm.

■MARKING RULE



1 represents products series

MARK	PRODUCT SERIES
1	XCL101*****-G

2 represents integer portion of the output voltage

XCL101A*****

V _{OUT} (V)	MARK
1.x	1
2.x	2
3.x	3
4.x	4
5.x	5

XCL101C*****	
V _{OUT} (V)	MARK
1.x	В
2.x	С
3.x	D
4.x	E
5.x	F

CL-2025/CL-2025-02

③ represents the decimal part of output voltage

V _{OUT} (V)	MARK	PRODUCT SERIES		
X.0 0		XCL101**0***-G		
X.1 1		XCL101**1***-G		
X.2	2	XCL101**2***-G		
X.3	3	XCL101**3***-G		
X.4	4	XCL101**4***-G		
X.5 5		XCL101**5***-G		
X.6	6	XCL101**6***-G		
X.7 7		XCL101**7***-G		
X.8 8		XCL101**8***-G		
X.9 9		XCL101**9***-G		

Example (mark(2), (3)

MARK								
XCL101A33***-G		XCL101C28***-G		XCL101A50***-G				
2	3	2	3	2	3			
3	3	С	8	5	0			

④, ⑤ represents production lot number

01~09, 0A~0Z, 11~9Z, A1~A9, AA~AZ, B1~ZZ in order.

(G, I, J, O, Q, W excluded)

* No character inversion used.